

ALPHANUMERIC INDEX — CROSS-REFERENCE (Continued)

Industry Part Number	Motorola Direct Replacement	Motorola Similar Replacement	Page Number	Industry Part Number	Motorola Direct Replacement	Motorola Similar Replacement	Page Number
BU806	BU806	MJE16002	3-380	BUW12A	BUW12A	MJE13008	3-476
BU807	BU807		3-380	BUW13	BUV48P		3-469
BUS11			3-976	BUW13A	BUV48A		3-469
BUS12	BUX47		3-499	BUW24	BU326A		3-363
BUS12A	BUX47A		3-499	BUW25	BU326A		3-363
BUS13	BUX48	MJE16002	3-506	BUW26	BUS326A	MJE13008	—
BUS13A	BUX48A		3-506	BUW34	BUX47		3-499
BUS14	BUX98		—	BUW35	BUX47		3-499
BUS14A	BUX98A		—	BUW36	BUX47A		3-499
BUS46P			3-976	BUW44	BUX48		3-506
BUS47	BUX47	MJE16002	3-499	BUW45	BUX48	MJE13008	3-506
BUS47A	BUX47A		3-499	BUW46	BUX48A		3-506
BUS47AP	BUV47A		3-462	BUW72			3-950
BUS47P	BUV47		3-462	BUW74	BUX47		3-499
BUS48	BUX48		3-506	BUW75	BUX47		3-499
BUS48A	BUX48A	BUS51	3-506	BUW76	BUX47	MJE13003	3-499
BUS48AP	BUV48A		3-469	BUW77	BUX47		3-499
BUS48P	BUV48		3-469	BUW81	MJ10014		3-600
BUS50	BUS50		3-382	BUW81A	MJ10014		3-600
BUS51	BUS51		3-384	BUW84	MJE13003		3-938
BUS52		BUS51	3-384	BUW85	MJE13003	MJE13003	3-938
BUS97	MJ16010		3-758	BUX13	BUX13		3-484
BUS97A	MJ16010A		3-766	BUX14	BUX14		—
BUS98	BUX98		—	BUX14CECCF	BUX14		—
BUS98A	BUX98A		—	BUX14CECCL	BUX14		—
BUT13	BUT13	BUS51	3-393	BUX15	BUX47A	MJE13003	3-499
BUT14	BUT14		3-399	BUX15CECCF	BUX47A		3-499
BUT15	BUT15		3-405	BUX15CECCL	BUX47A		3-499
BUT33	BUT33		3-411	BUX16	2N6543		3-215
BUT34	BUT34		3-417	BUX16A	2N6543		3-215
BUT35	BUT35	BUS51	3-423	BUX16B	2N6543	MJE13003	3-215
BUT50P	BUT50P		3-429	BUX16C	2N6543		3-215
BUT51P	BUT51P		3-431	BUX17	BUX48		3-506
BUT90	BUS50		3-382	BUX17A	BUX48		3-506
BUT91	BUS51		3-384	BUX17B	BUX48		3-506
BUT92		BUS51	3-384	BUX17C	BUX48	MJE13003	3-506
BUV10			3-432	BUX18	2N6545		3-221
BUV10N	BUV10N		3-432	BUX18A	2N6545		3-221
BUV11	BUV11		3-435	BUX18B	2N6545		3-221
BUV11N			3-435	BUX18C	2N6545		3-221
BUV12	BUV12	BUS50	3-441	BUX39	BUX39	MJE13003	3-487
BUV18			3-382	BUX40	BUX40		3-490
BUV19			3-382	BUX41	BUX41		3-493
BUV20	BUV20		3-444	BUX41N			3-493
BUV21	BUV21		3-447	BUX42			3-484
BUV21N		BUS50	3-447	BUX43		MJE13003	3-484
BUV22	BUV22		3-453	BUX47	BUX47		3-499
BUV23	BUV23		3-456	BUX47A	BUX47A		3-499
BUV24			3-386	BUX48	BUX48		3-506
BUV25			3-386	BUX48A	BUX48A		3-506
BUV44	BUX47	BUS50	3-499	BUX48S	BUX48	MJE13003	3-506
BUV45	BUX47A		3-499	BUX66	2N6211		3-161
BUV46	2N6543		3-215	BUX66A	2N6212		3-161
BUV47	BUV47		3-462	BUX66B	2N6212		3-161
BUV47A	BUV47A		3-462	BUX66C	2N6213		3-161
BUV48	BUV48	BUS50	3-469	BUX67	2N3584	MJE13003	3-20
BUV48A	BUV48A		3-469	BUX67A	2N3584		3-20
BUW11	BUW11		3-476	BUX67B	2N3585		3-20
BUW11A	BUW11A		3-476	BUX67C	2N4240		3-20
BUW12	BUW12		3-476	BUX81			3-700

*Consult Motorola if a direct replacement is necessary.

TABLE 1 — METAL TO-204, TO-204AE (continued)

I _C Cont Amps Max	V _{CEO(sus)} Volts Min	Device Type		h _{FE} Min/Max	@ I _C Amp	Resistive Switching			f _T MHz Min	P _D (Case) Watts @ 25°C
		NPN	PNP			t _s μs Max	t _f μs Max	@ I _C Amp		
10	250	MJ15011	MJ15012	20/100	2					200
	300	MJ3041##		250 min	2.5					175
	325	MJ413 MJ423 MJ431		20/80 30/90 15/35	0.5 1 2.5				2.5 2.5 2.5	125 125 125
	350	BU323## MJ3042## MJ13014 MJ10002## MJ10006##		150 min 250 min 8/20 3/300 30/300	6 2.5 5 5 5	7.5 typ 2 2.5 1.5	5.2 typ 0.5 1 0.5	6 5 5 5	10# 10#	175 175 150 150 150
	400	BU323A## MJ10007## MJ10012## MJ13015		150 min 30/300 100/2k 8/20	6 5 6 5	7.5 typ 1.5 15 2	5.2 typ 0.5 15 0.5	6 5 6 5	10#	175 150 175 150
	600	MJ10014##		10/250	10	2.5	0.8	10		175
	700	MJ8504		7.5 min	1.5	4	2	5		175
	800	MJ8505 MJ16018		7.5 min 4 min	1.5 5	4 4.5 typ	2 0.2 typ	5 5		175 150
	950*	MJ12010		4.2 min	5		1	5		100
12	60	2N6057##	2N6050##	750/18k	6	1.6 typ	1.5 typ	6	4#	150
	80	2N6058##	2N6051##	750/18k	6	1.6 typ	1.5 typ	6	4#	150
	100	2N6059##	2N6052##	750/18k	6	1.6 typ	1.5 typ	6	4#	150
15	60	2N3055 2N3055A 2N6576## 2N5881	MJ2955 MJ2955A 2N5879	20/70 20/70 2k/20k 20/100	4 4 4 6	0.7 typ 2 1	0.3 typ 7 0.8	4 10 6	2.5 0.8 10-200# 4	115 115 120 160
	80	2N5882	2N5880	20/100	6	1	0.8	6	4	160
	90	2N6577##		2k/20k	4	2	7	10	10-200#	120
	120	MJ15015 2N6578##	MJ15016	20/70 2k/20k	4 4	2	7	10	1 10-200#	180 120
	140	MJ15001	MJ15002	25/150	4				2	200
	150	MJ11018##	MJ11017##	100 min	15				3#	175
	200	BUX41 2N6249 MJ11020##	MJ11019##	8 min 10/50 100 min	8 10 15	1.5 3.5	0.4 1	8 10	8 2.5 3#	120 175 175
	250	MJ11022##	MJ11021##	100 min	15				3#	175
	275	2N6250		8/50	10	3.5	1	10	2.5	175
	300	2N6546		6/30	10	4	0.7	10	6 to 24	175
	325	BUX13		8 min	8	2.5	0.8	8	8	150
	400	BUX48 2N6547 MJ13090 MJ16110		8 min 6/30 8 min 6/20	10 10 10 15	2 4 2.5 0.8 typ	0.4 0.7 0.5 0.1 typ	10 10 10	6 to 24	175 175 175 175
	450	BUX48A MJ16010		8 min 5 min	8 15	2 1.2 typ	0.4 0.2 typ	10 10		175 175

* V_{BR}/C_{EX}. # |h_{FE}| @ 1 MHz, ## Darlington

(continued)

 JAN, JTX, JTXV Available

TABLE 14 — SWITCHMODE POWER TRANSISTORS (continued)

V _{CEO(sus)} Volts Min	I _C Cont Amps Max	V _{CEV} Volts Min	Device Type NPN unless otherwise noted	h _{FE} Min/Max	@ I _C Amp	Resistive Switching			f _T MHz Min	P _D (Case) Watts @ 25°C	Case JEDEC/MOT
						t _s μs Max	t _f μs Max	@ I _C Amp			
450	15	1000	BUV48A	8 min	8	2	0.4	10		150	TO-218/340D
	9	1000	BUS47A	7 min	5	2	0.4	5		150	TO-204/1
		1000	BUS47AP	7 min	6	2	0.4	6		128	TO-218/340D
	8	850	2N6835★	7.5/3	5	2.5	0.25	5	10		TO-204/1
		850	MJE16080	5 min	8	2	0.5	5		80	TO-220/221A
		850	MJ12021★	5 min	8		0.1 typ	8			TO-204/1
		850	MJ16006★	5 min	8	2.5	0.25	5			TO-204/1
		850	MJ16008★	7 min	8	2.2	0.25	5			TO-204/1
		850	MJH16006★	5 min	8	2.5	0.25	5			TO-218/340
		850	MJH16008★	7 min	8	2.2	0.25	5			TO-218/340
		1000	BUW12A	6 min	5	4	0.8	5		125	TO-218/340
	5	850	2N6834★	10/30	3	2.7	0.35	3			TO-204/1
		850	MJ12020★	5 min	5		0.13 typ	3	15		TO-204/1
		850	MJ16002★	5 min	5	3	0.3	3			TO-204/1
		850	MJ16004★	8 min	3	2.7	0.35	3			TO-204/1
		850	MJE16002★	5 min	5	3	0.3	3			TO-220/221A
		850	MJE16004★	7 min	5	2.7	0.35	3			TO-220/221A
		850	MJH16002★	5 min	5	3	0.3	3			TO-218/340
		850	MJH16004★	7 min	5	2.7	0.35	3			TO-218/340
		1000	BUW11A	6 min	2.5	4	0.8	2.5		125	TO-218/340
	3	1000	BUX85	30 min	0.1	3.5	1.4	1	4	50	TO-220/221A
400	56	600	BUT33##	20 min	36	3.3	1.6	36		250	TO-204/197
	50	650	MJ10015###★	10 min	40	2.5	1	20			TO-204/197
	40	600	MJ10023###★	50/600	10	2.5	0.9	20			TO-204/197
	30	850	BUS98	8 min	20	2.3	0.4	20		250	TO-204/197
	28	600	BUT13##	20 min	20	2.6	0.8	18		175	TO-204/1
	20	500	MJ10001##★	40/400	10	3	1.8	10	10**		TO-204/1
		500	MJ10005##★	40/400	10	1.5	0.5	10	10**		TO-204/1
		500	MJ13333★	10/60	5	4	0.7	10			TO-204/1
	15	650	MJ13090★	8 min	10	2.5	0.5	10			TO-204/1
		650	MJ16110	6/20	15	0.8 typ	0.1 typ	10		175	TO-204/1
		650	MJH16110	6/20	15	0.8 typ	0.1 typ	10		135	TO-218/340
		850	2N6547★	6/30	10	4	0.7	10	6 to 24		TO-204/1
		850	BUX48	8 min	10	2	0.4	10		175	TO-204/1
		850	BUV48	8 min	10	2	0.4	10		150	TO-218/340D
	12	700	MJE13009★	6/30	8	3	0.7	8	4**		TO-220/221A
	10	950	MJ12010	4.2 min	5		1	5	6 typ		TO-204/1
		550	MJ10012#	100/2k	6	6	15	15	6		TO-204/1
		500	MJ10003##★	30/300	5	2.5	1	5	10**		TO-204/1
		500	MJ10007###★	30/300	5	1.1	0.25	5	10**		TO-204/1
		450	MJ13015★	8/20	5	2	0.5	5			TO-204/1
	9	850	BUS47	7 min	6	2	0.4	6		150	TO-204/1
		850	BUS47P	7 min	5	2	0.4	6		128	TO-218/340D

★ Designers Data Sheet characterization
Darlington ## Darlington with speed-up diode

* t_{off} ** |h_{FE}| @ 1 MHz

(continued)

BUX48
BUX48A

SWITCHMODE II SERIES
NPN SILICON POWER TRANSISTORS

The BUX 48/BUX 48A transistors are designed for high-voltage, high-speed, power switching in inductive circuits where fall time is critical. They are particularly suited for line-operated switchmode applications such as:

- Switching Regulators
- Inverters
- Solenoid and Relay Drivers
- Motor Controls
- Deflection Circuits

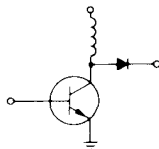
Fast Turn-Off Times

60 ns Inductive Fall Time — 25°C (Typ)
120 ns Inductive Crossover Time — 25°C (Typ)

Operating Temperature Range -65 to +200°C

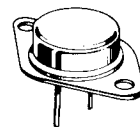
100°C Performance Specified for:

Reverse-Biased SOA with Inductive Loads
Switching Times with Inductive Loads
Saturation Voltage
Leakage Currents (125°C)



15 AMPERES
NPN SILICON
POWER TRANSISTORS

400 AND 450 VOLTS
V(BR)CEO
850 - 1000 VOLTS
V(BR)CEX
175 WATTS



CASE 1-06
TO-204AA
(TO-3)

MAXIMUM RATINGS

Rating	Symbol	BUX48	BUX48A	Unit
Collector-Emitter Voltage	V _{CEO(sus)}	400	450	V _{dc}
Collector-Emitter Voltage (V _{BE} = -1.5V)	V _{CEX}	850	1000	V _{dc}
Emitter Base Voltage	V _{EB}	7		V _{dc}
Collector Current — Continuous	I _C	15		A _{dc}
— Peak (1)	I _{CM}	30		
— Overload	I _{OI}	60		
Base Current — Continuous	I _B	5		A _{dc}
— Peak (1)	I _{BM}	20		
Total Power Dissipation — T _C = 25°C	P _D	175		Watts
— T _C = 100°C		100		
Derate above 25°C		1		W/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +200		°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	R _{θJC}	1	°C/W
Maximum Lead Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	T _L	275	°C

(1) Pulse Test: Pulse Width ≤ 5 ms, Duty Cycle ≤ 10%.

Switchmode is a trademark of Motorola Inc.

BUX48, BUX48A

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS (1)					
Collector-Emitter Sustaining Voltage (Table 1) ($I_C = 200\text{ mA}$, $I_B = 0$) $L = 25\text{ mH}$ BUX 48 BUX 48A	$V_{CE(sus)}$	400 450	— —	— —	Vdc
Collector Cutoff Current ($V_{CEX} = \text{Rated Value}$, $V_{BE(off)} = 1.5\text{ Vdc}$) ($V_{CEX} = \text{Rated Value}$, $V_{BE(off)} = 1.5\text{ Vdc}$, $T_C = 125^\circ\text{C}$)	I_{CEX}	— —	— —	0.2 2	mAdc
Collector Cutoff Current ($V_{CE} = \text{Rated } V_{CEX}$, $R_{BE} = 10\ \Omega$) $T_C = 25^\circ\text{C}$ $T_C = 125^\circ\text{C}$	I_{CER}	— —	— —	0.5 3	mAdc
Emitter Cutoff Current ($V_{EB} = 5\text{ Vdc}$, $I_C = 0$)	I_{EBO}	—	—	0.1	mAdc
Emitter-Base Breakdown Voltage ($I_E = 50\text{ mA}$, $I_C = 0$)	$V_{(BR)EBO}$	7	—	—	Vdc

SECOND BREAKDOWN

Second Breakdown Collector Current with Base Forward Biased	$I_{S,b}$	See Figure 12	
Clamped Inductive SOA with Base Reverse Biased	RBSOA	See Figure 13	

ON CHARACTERISTICS (1)

DC Current Gain ($I_C = 10\text{ Adc}$, $V_{CE} = 5\text{ Vdc}$) ($I_C = 8\text{ Adc}$, $V_{CE} = 5\text{ Vdc}$) BUX48 BUX48A	h_{FE}	8 8	— —	— —	
Collector-Emitter Saturation Voltage ($I_C = 10\text{ Adc}$, $I_B = 2\text{ Adc}$) ($I_C = 15\text{ Adc}$, $I_B = 3\text{ Adc}$) ($I_C = 10\text{ Adc}$, $I_B = 2\text{ Adc}$, $T_C = 100^\circ\text{C}$) ($I_C = 8\text{ Adc}$, $I_B = 1.6\text{ Adc}$) ($I_C = 12\text{ Adc}$, $I_B = 2.4\text{ Adc}$) ($I_C = 8\text{ Adc}$, $I_B = 1.6\text{ Adc}$, $T_C = 100^\circ\text{C}$) BUX48 BUX48A	$V_{CE(sat)}$	— — — — — —	— — — — — —	1.5 5 2 1.5 5 2	Vdc
Base-Emitter Saturation Voltage ($I_C = 10\text{ Adc}$, $I_B = 2\text{ Adc}$) ($I_C = 10\text{ Adc}$, $I_B = 2\text{ Adc}$, $T_C = 100^\circ\text{C}$) ($I_C = 8\text{ Adc}$, $I_B = 1.6\text{ Adc}$) ($I_C = 8\text{ Adc}$, $I_B = 1.6\text{ Adc}$, $T_C = 100^\circ\text{C}$) BUX48 BUX48A	$V_{BE(sat)}$	— — — —	— — — —	1.6 1.6 1.6 1.6	Vdc

DYNAMIC CHARACTERISTICS

Output Capacitance ($V_{CB} = 10\text{ Vdc}$, $I_E = 0$, $f_{test} = 1\text{ MHz}$)	C_{ob}	—	—	350	pF
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SWITCHING CHARACTERISTICS

Resistive Load (Table 1)

Delay Time	$I_C = 10\text{ A}$, $I_B = 2\text{ A}$ BUX48	t_d	—	0.1	0.2	μs
Rise Time	$I_C = 8\text{ A}$, $I_B = 1.6\text{ A}$ BUX48A	t_r	—	0.4	0.7	
Storage Time	Duty Cycle = 2%, $V_{BE(off)} = 5\text{ V}$	t_s	—	1.3	2	
Fall Time	$T_p = 30\mu\text{s}$, $V_{CC} = 300\text{ V}$	t_f	—	0.2	0.4	

Inductive Load, Clamped (Table 1)

Storage Time	$I_C = 10\text{ A}$ $I_B = 2\text{ A}$ BUX 48	($T_C = 25^\circ\text{C}$)	t_{sv}	—	1.3	—	μs
Fall Time			t_{fi}	—	0.06	—	
Storage Time	$I_C = 8\text{ A}$ $I_B = 1.6\text{ A}$ BUX48A	($T_C = 100^\circ\text{C}$)	t_{sv}	—	1.5	2.5	
Crossover Time			t_c	—	0.3	0.6	
Fall Time			t_{fi}	—	0.17	0.35	

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle = 2%.

$V_{cl} = 300\text{ V}$, $V_{BE(off)} = 5\text{ V}$, $L_c = 180\mu\text{H}$

BUX48, BUX48A

DC CHARACTERISTICS

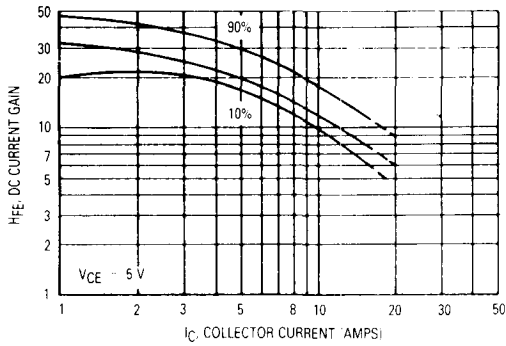


Figure 1. DC Current Gain

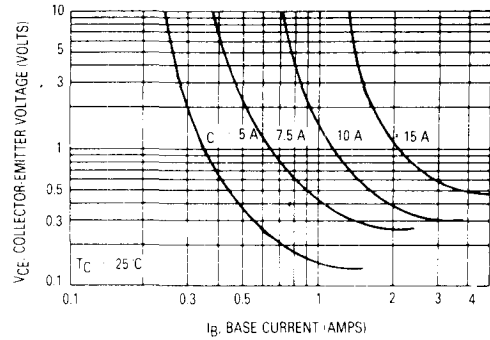


Figure 2. Collector Saturation Region

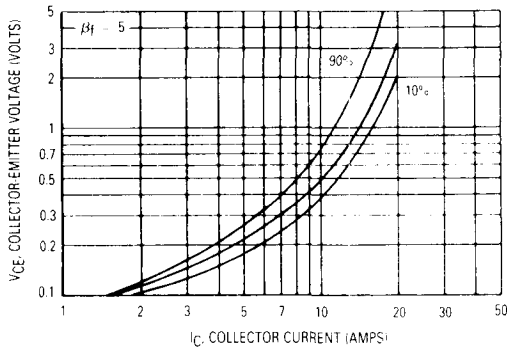


Figure 3. Collector-Emitter Saturation Voltage

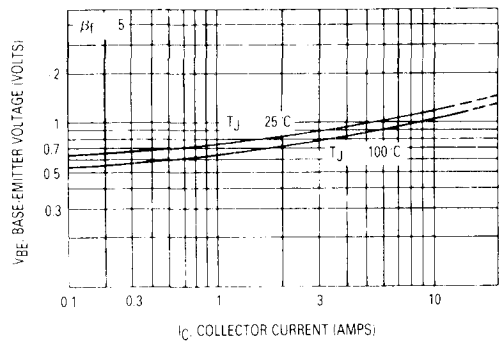


Figure 4. Base-Emitter Voltage

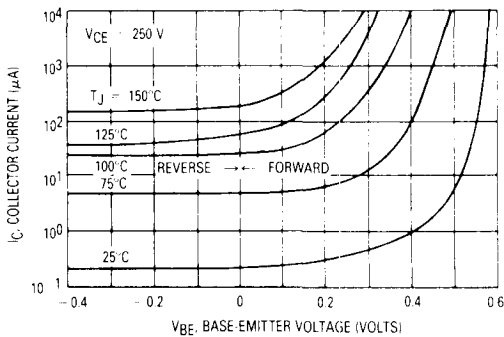


Figure 5. Collector Cutoff Region

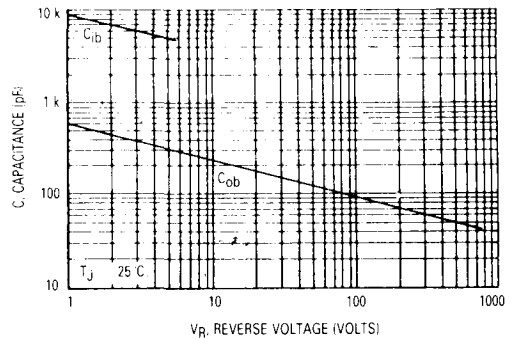
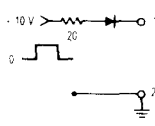
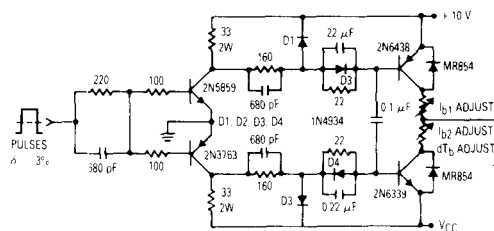
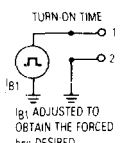
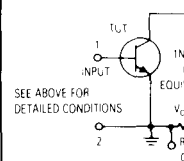
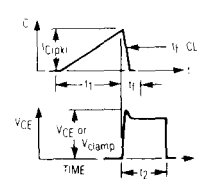
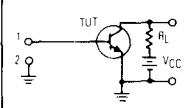


Figure 6. Capacitance

BUX48, BUX48A

Table 1. Test Conditions for Dynamic Performance

	$V_{CEO(sus)}$	RBSOA and Inductive Switching	Resistive Switching
Input Conditions	 PW Varied to Attain $I_C = 200 \text{ mA}$		 TURN ON TIME I_{B1} ADJUSTED TO OBTAIN THE FORCED h_{FE} DESIRED TURN OFF TIME USE INDUCTIVE SWITCHING DRIVER AS THE INPUT TO THE RESISTIVE TEST CIRCUIT
Circuit Values	$L_{coil} = 25 \text{ mH}$ $R_{coil} = 0.7 \Omega$ $V_{CC} = 10 \text{ V}$	$L_{CO} = 180 \mu\text{H}$ $R_{CO} = 0.05 \Omega$ $V_{CC} = 20 \text{ V}$ $V_{clamp} = 300 \text{ V}$ R_B ADJUSTED TO ATTAIN DESIRED I_{B1}	$V_{CC} = 300 \text{ V}$ $R_L = 83 \Omega$ PULSE WIDTH $10 \mu\text{s}$
Test Circuits	Inductive Test Circuit  SEE ABOVE FOR DETAILED CONDITIONS Output Waveforms  t_1 ADJUSTED TO OBTAIN I_C $t_1 = \frac{L_{CO} \cdot I_{C(pk)}}{V_{CC}}$ $t_2 = \frac{L_{CO} \cdot I_{C(pk)}}{V_{clamp}}$ TEST EQUIPMENT SCOPE — TEKTRONIX 475 OR EQUIVALENT	Resistive Test Circuit 	

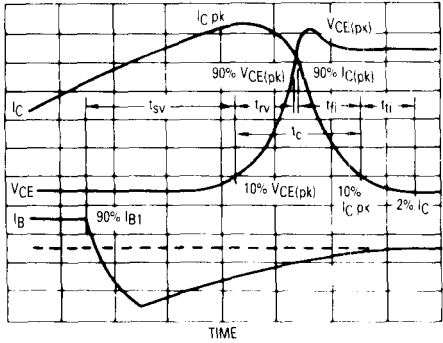


Figure 7. Inductive Switching Measurements

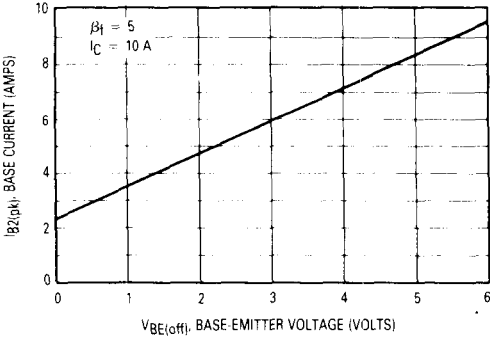


Figure 8. Peak-Reverse Current

BUX48, BUX48A

SWITCHING TIMES NOTE

In resistive switching circuits, rise, fall, and storage times have been defined and apply to both current and voltage waveforms since they are in phase. However, for inductive loads which are common to SWITCHMODE power supplies and hammer drivers, current and voltage waveforms are not in phase. Therefore, separate measurements must be made on each waveform to determine the total switching time. For this reason, the following new terms have been defined.

- t_{sv} = Voltage Storage Time, 90% I_{B1} to 10% V_{clamp}
- t_{rv} = Voltage Rise Time, 10–90% V_{clamp}
- t_{fi} = Current Fall Time, 90–10% I_C
- t_{ti} = Current Tail, 10–2% I_C
- t_c = Crossover Time, 10% V_{clamp} to 10% I_C

An enlarged portion of the inductive switching wave-

forms is shown in Figure 7 to aid in the visual identity of these terms.

For the designer, there is minimal switching loss during storage time and the predominant switching power losses occur during the crossover interval and can be obtained using the standard equation from AN-222:

$$P_{SWT} = 1/2 V_{CC} I_C (t_c) f$$

In general, $t_{rv} + t_{fi} = t_c$. However, at lower test currents this relationship may not be valid.

As is common with most switching transistors, resistive switching is specified at 25°C and has become a benchmark for designers. However, for designers of high frequency converter circuits, the user oriented specifications which make this a "SWITCHMODE" transistor are the inductive switching speeds (t_c and t_{sv}) which are guaranteed at 100°C.

INDUCTIVE SWITCHING

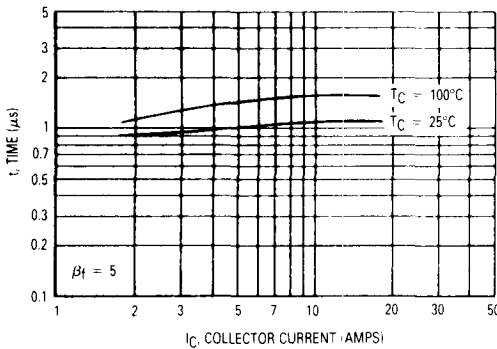


Figure 9. Storage Time, t_{sv}

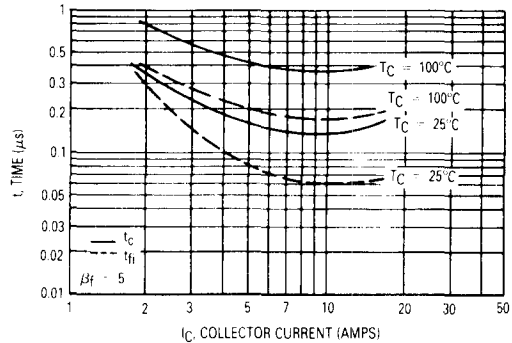


Figure 10. Crossover and Fall Times

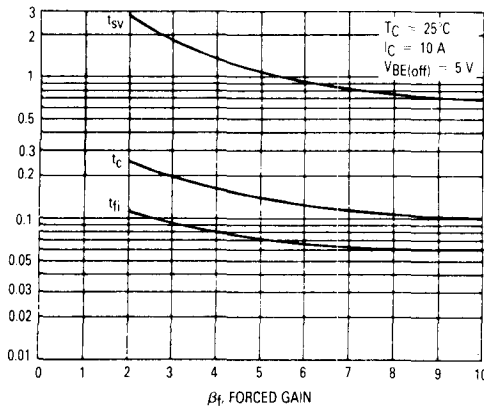


Figure 11a. Turn-Off Times versus Forced Gain

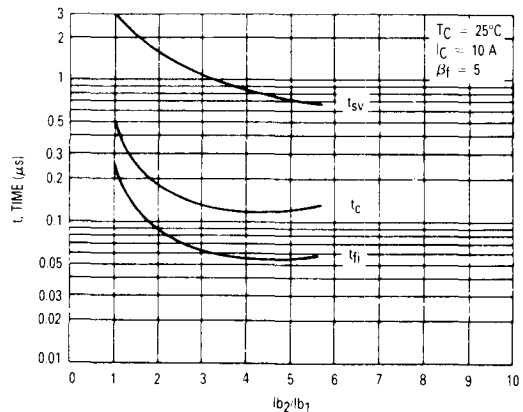


Figure 11b. Turn-Off Times versus I_{B2}/I_{B1}

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The Safe Operating Area figures shown in Figures 12 and 13 are specified for these devices under the test conditions shown.

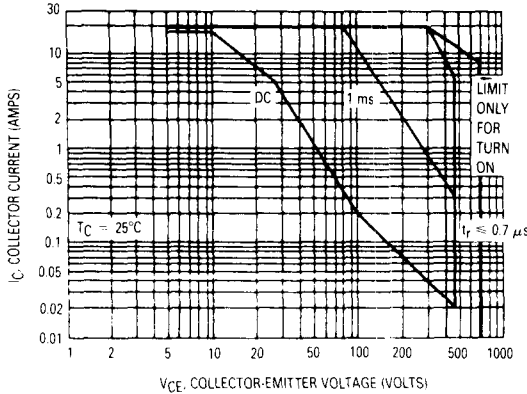


Figure 12. Forward Bias Safe Operating Area

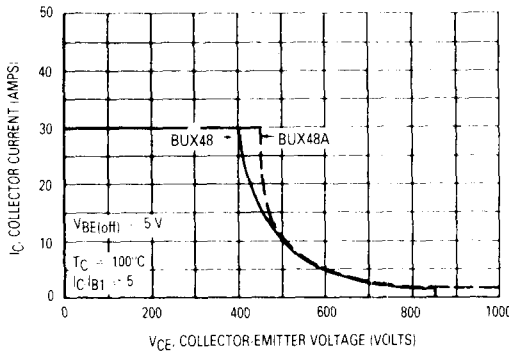


Figure 13. Reverse Bias Safe Operating Area

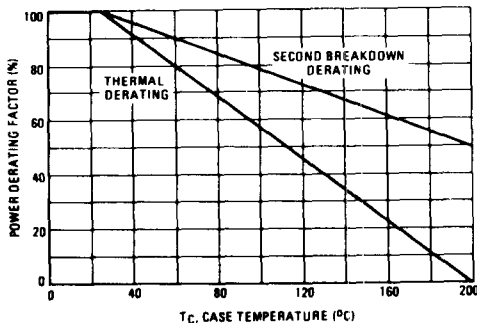


FIGURE 14 - POWER DERATING

SAFE OPERATING AREA INFORMATION

FORWARD BIAS

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate I_C - V_{CE} limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

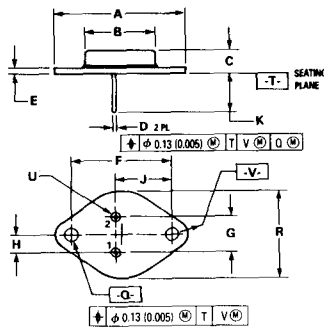
The data of Figure 12 is based on $T_C = 25^\circ\text{C}$; $T_J(\text{pk})$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated when $T_C \geq 25^\circ\text{C}$. Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown on Figure 12 may be found at any case temperature by using the appropriate curve on Figure 14.

$T_J(\text{pk})$ may be calculated from the data in Figure 11. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

REVERSE BIAS

For inductive loads, high voltage and high current must be sustained simultaneously during turn-off, in most cases, with the base to emitter junction reverse biased. Under these conditions the collector voltage must be held to a safe level at or below a specific value of collector current. This can be accomplished by several means such as active clamping, RC snubbing, load line shaping, etc. The safe level for these devices is specified as Reverse Bias Safe Operating Area and represents the voltage-current conditions during reverse biased turn-off. This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode. Figure 13 gives RBSOA characteristics.

OUTLINE DIMENSIONS



STYLE 1:
PIN 1: BASE
2: EMITTER
CASE: COLLECTOR

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	—	39.37	—	1.550
B	—	21.08	—	0.830
C	6.35	8.25	0.250	0.325
D	0.97	1.09	0.038	0.043
E	1.40	1.77	0.055	0.070
F	30.15 BSC	—	1.187 BSC	—
G	10.92 BSC	—	0.430 BSC	—
H	5.46 BSC	—	0.215 BSC	—
J	16.89 BSC	—	0.665 BSC	—
K	11.18	12.19	0.440	0.480
Q	3.84	4.19	0.151	0.165
R	—	26.67	—	1.050
U	4.83	5.33	0.190	0.210
V	3.84	4.19	0.151	0.165

NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. ALL RULES AND NOTES ASSOCIATED WITH REFERENCED TO-204AA OUTLINE SHALL APPLY.

CASE 1-06
TO-204AA
(TO-3)

BUX48, BUX48A

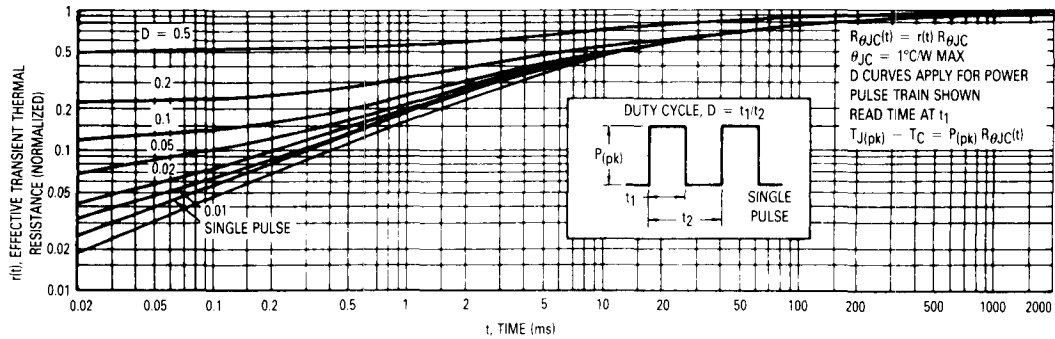


Figure 15. Thermal Response

OVERLOAD CHARACTERISTICS

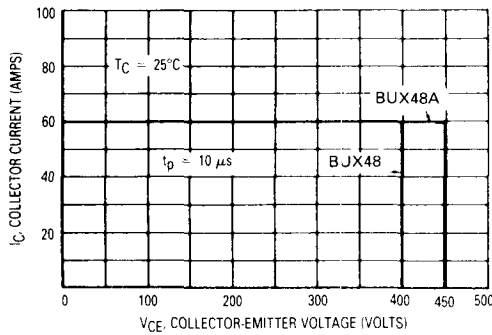


Figure 16. Rated Overload Safe Operating Area (OLSOA)

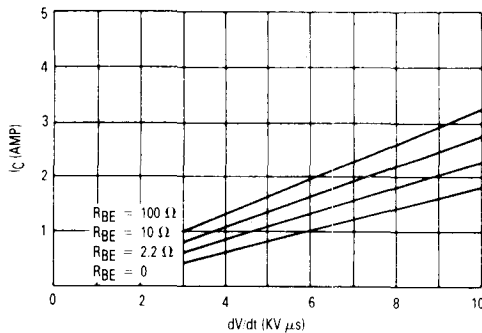


Figure 17. $I_C = f(dV/dt)$

OLSOA

OLSOA applies when maximum collector current is limited and known. A good example is a circuit where an inductor is inserted between the transistor and the bus, which limits the rate of rise of collector current to a known value. If the transistor is then turned off within a specified amount of time, the magnitude of collector current is also known.

Maximum allowable collector-emitter voltage versus collector current is plotted for several pulse widths. (Pulse width is defined as the time lag between the fault condition and the removal of base drive.) Storage time of the transistor has been factored into the curve. Therefore, with bus voltage and maximum collector current known, Figure 16 defines the maximum time which can be allowed for fault detection and shutdown of base drive.

OLSOA is measured in a common-base circuit (Figure 18) which allows precise definition of collector-emitter voltage and collector current. This is the same circuit that is used to measure forward-bias safe operating area.

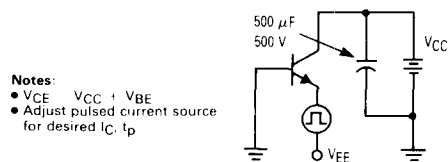


Figure 18. Overload SOA Test Circuit

- Notes:
- $V_{CE} = V_{CC} + V_{BE}$
 - Adjust pulsed current source for desired I_C , t_p